

# TEMIC

Siliconix

# VN0610L, VN10KE/KM, VN2222L

## N-Channel Enhancement-Mode MOS Transistors

### Zener Gate Protected

### Product Summary

Part Number	$V_{(BR)DSS}$ Min (V)	$r_{DS(on)}$ Max ( $\Omega$ )	$V_{GS(th)}$ (V)	$I_D$ (A)
VN0610L	60	5 @ $V_{GS} = 10$ V	0.8 to 2.5	0.27
VN10KE		5 @ $V_{GS} = 10$ V	0.8 to 2.5	0.17
VN10KM		5 @ $V_{GS} = 10$ V	0.8 to 2.5	0.31
VN2222L		7.5 @ $V_{GS} = 10$ V	0.6 to 2.5	0.23

### Features

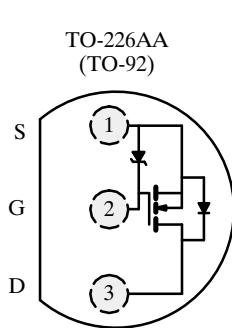
- Zener Diode Input Protected
- Low On-Resistance: 3  $\Omega$
- Ultralow Threshold: 1.2 V
- Low Input Capacitance: 38 pF
- Low Input and Output Leakage

### Benefits

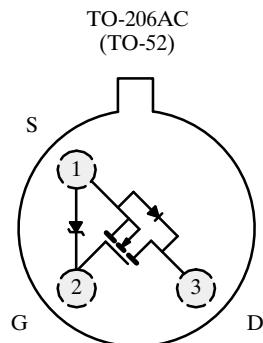
- Extra ESD Protection
- Low Offset Voltage
- Low-Voltage Operation
- High-Speed, Easily Driven
- Low Error Voltage

### Applications

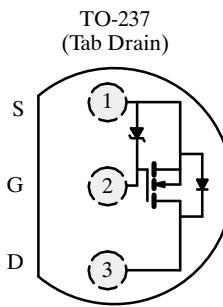
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays
- Inductive Load Drivers



Top View  
VN0610L  
VN2222L



Top View  
VN10KE



Top View  
VN10KM

### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	VN0610L	VN10KE	VN10KM	VN2222L	Unit
Drain-Source Voltage	$V_{DS}$	60	60	60	60	V
Gate-Source Voltage	$V_{GS}$	15/-0.3	15/-0.3	15/-0.3	15/-0.3	
Continuous Drain Current ( $T_J = 150^\circ\text{C}$ )	$I_D$	0.27	0.17	0.31	0.23	A
		0.17	0.11	0.20	0.14	
Pulsed Drain Current	$I_{DM}$	1	1	1	1	
Power Dissipation	$P_D$	0.8	0.3	1	0.8	W
		0.32	0.12	0.4	0.32	
Maximum Junction-to-Ambient	$R_{thJA}$	156	400	125	156	$^\circ\text{C}/\text{W}$
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 150				$^\circ\text{C}$

Notes

a. Pulse width limited by maximum junction temperature.

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## Specifications<sup>a</sup>

Parameter	Symbol	Test Conditions	Typ <sup>b</sup>	Limits				Unit	
				VN0610L VN10KE VN10KM		VN2222L			
				Min	Max	Min	Max		
<b>Static</b>									
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 100 µA	120	60		60		V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1 mA	1.2	0.8	2.5	0.6	2.5		
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 15 V	1		100		100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V T <sub>J</sub> = 125°C			10		10	µA	
On-State Drain Current <sup>c</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V	1	0.75		0.75			
Drain-Source On-Resistance <sup>c</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 0.2 A	4		7.5		7.5	Ω	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A T <sub>J</sub> = 125°C	3		5		7.5		
			5.6		9		13.5		
Forward Transconductance <sup>c</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.5 A	300	100		100		mS	
Common Source Output Conductance <sup>c</sup>	g <sub>os</sub>	V <sub>DS</sub> = 7.5 V, I <sub>D</sub> = 0.05 A	0.2						
<b>Dynamic</b>									
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	38		60		60	pF	
Output Capacitance	C <sub>oss</sub>		16		25		25		
Reverse Transfer Capacitance	C <sub>rss</sub>		2		5		5		
<b>Switching<sup>d</sup></b>									
Turn-On Time	t <sub>ON</sub>	V <sub>DD</sub> = 15 V, R <sub>L</sub> = 23 Ω I <sub>D</sub> ≈ 0.6 A, V <sub>GEN</sub> = 10 V R <sub>G</sub> = 25 Ω	7		10		10	ns	
Turn-Off Time	t <sub>OFF</sub>		9		10		10		

### Notes

a. T<sub>A</sub> = 25°C unless otherwise noted.

VNDP06

b. For DESIGN AID ONLY, not subject to production testing.

c. Pulse test: PW ≤ 300 µs duty cycle ≤ 2%.

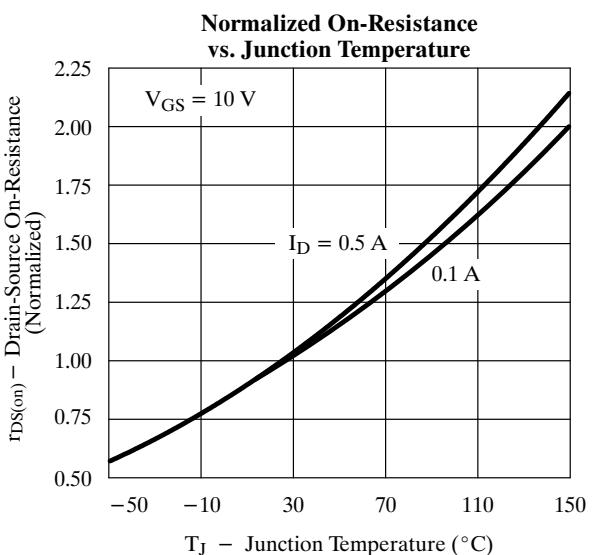
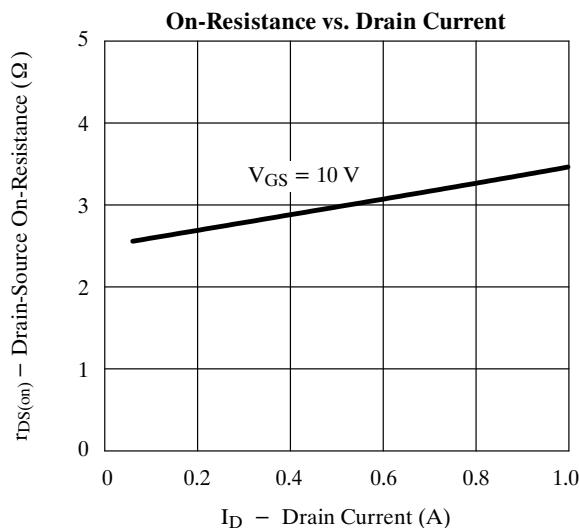
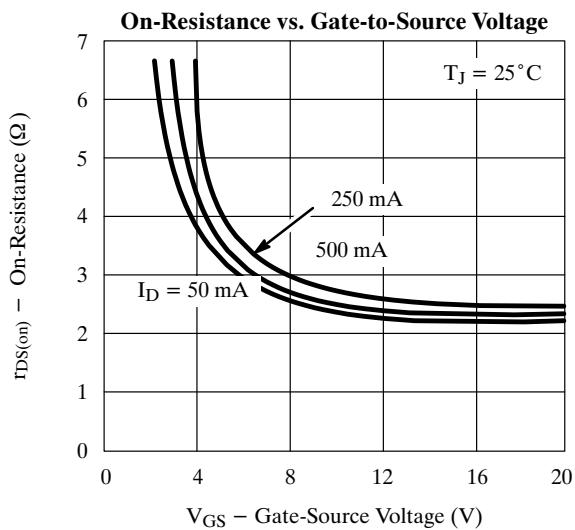
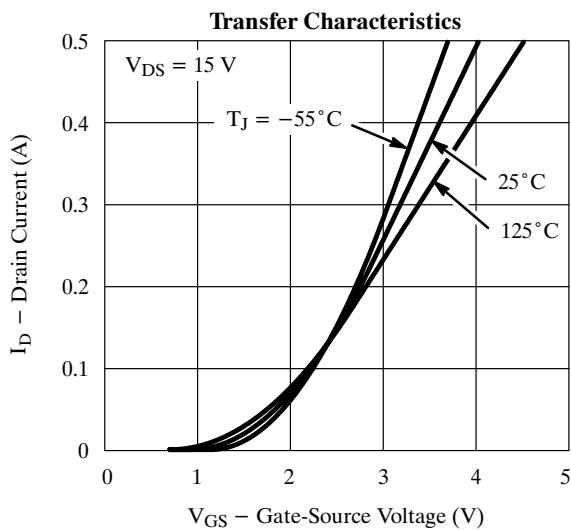
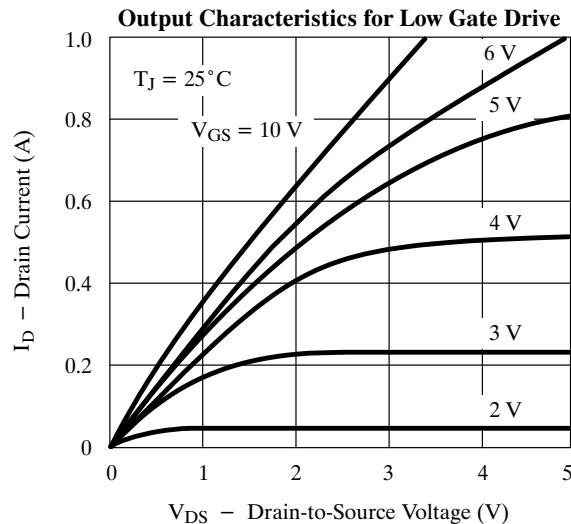
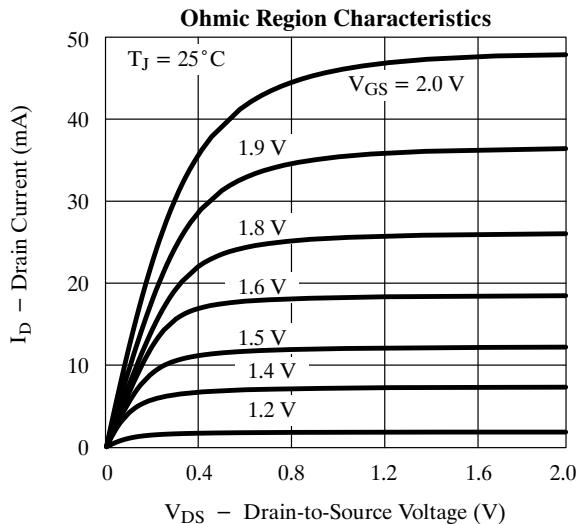
d. Switching time is essentially independent of operating temperature.

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**Typical Characteristics (25°C Unless Otherwise Noted)**



# VN0610L, VN10KE/KM, VN2222L

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## Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

